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(12) **United States Design Patent**  
**Huang**

(10) **Patent No.:** **US D744,361 S**

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(54) **DIGITAL MULTIMETER**

(56) **References Cited**

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(72) Inventor: **Wei Huang, Shanghai (CN)**

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(\*\*) Term: **14 Years**

(Continued)

(21) Appl. No.: **29/519,895**

*Primary Examiner* — Antoine D Davis

(22) Filed: **Mar. 9, 2015**

(74) *Attorney, Agent, or Firm* — Seed IP Law Group PLLC

**Related U.S. Application Data**

(63) Continuation of application No. 29/476,735, filed on Dec. 16, 2013, now Pat. No. Des. 723,959.

(57) **CLAIM**

The ornamental design for a digital multimeter, as shown and described.

(30) **Foreign Application Priority Data**

Jun. 19, 2013 (CN) ..... 2013 3 0263537

(51) **LOC (10) Cl.** ..... **10-04**

(52) **U.S. Cl.**  
USPC ..... **D10/78**

(58) **Field of Classification Search**  
USPC ..... D10/78; 324/66, 67, 158 P, 539–542, 324/72.5, 556, 133, 149, 503, 543, 555, 72, 324/754, 115, 141, 114, 145, 156, 508, 116, 324/99 D; 379/21, 60, 66, 96, 379/106.01–106.11; 340/635, 687, 654; 73/866.5; 200/11 R, 11 DA, 336, 341; 361/679.01

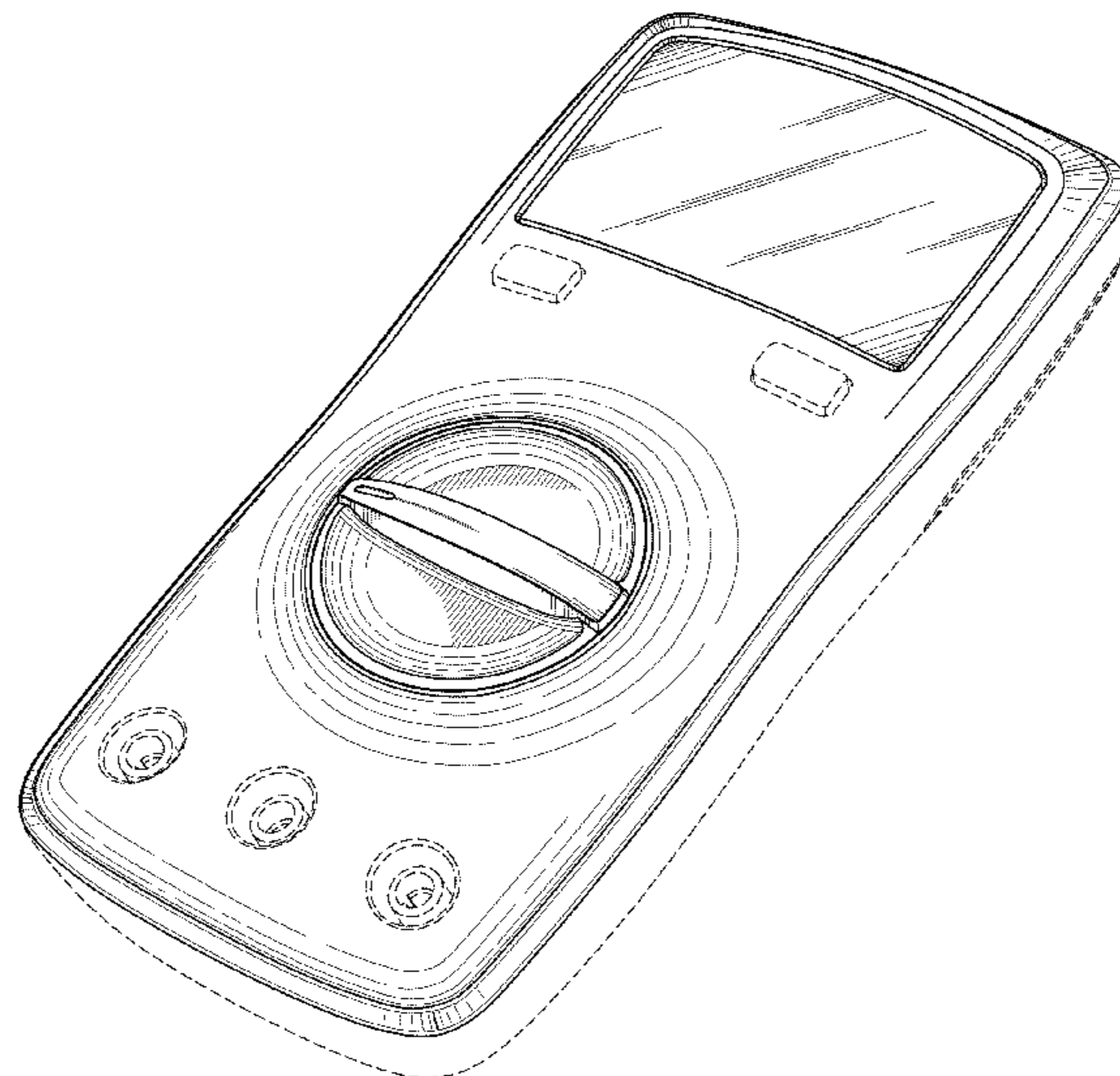
CPC ..... G01R 1/22; G01R 1/04; G01R 15/02; G01R 15/181; G01R 15/186; G01R 15/12; G01R 15/125; G01D 11/24; G06F 17/00

See application file for complete search history.

**DESCRIPTION**

FIG. 1 is a front elevation view of a digital multimeter showing my new design;  
FIG. 2 is a rear elevation view thereof;  
FIG. 3 is a left side elevation view thereof;  
FIG. 4 is a right side elevation view thereof;  
FIG. 5 is a top plan view thereof;  
FIG. 6 is a bottom plan view thereof;  
FIG. 7 is a bottom front right perspective view thereof;  
FIG. 8 is a front elevation view of another embodiment of a digital multimeter showing my new design;  
FIG. 9 is a rear elevation view thereof;  
FIG. 10 is a left side elevation view thereof;  
FIG. 11 is a right side elevation view thereof;  
FIG. 12 is a top plan view thereof;  
FIG. 13 is a bottom plan view thereof; and,  
FIG. 14 is a bottom front right perspective view thereof.  
Broken lines shown in the drawings illustrate environmental subject matter and form no part of the claimed design.

**1 Claim, 10 Drawing Sheets**



(56)

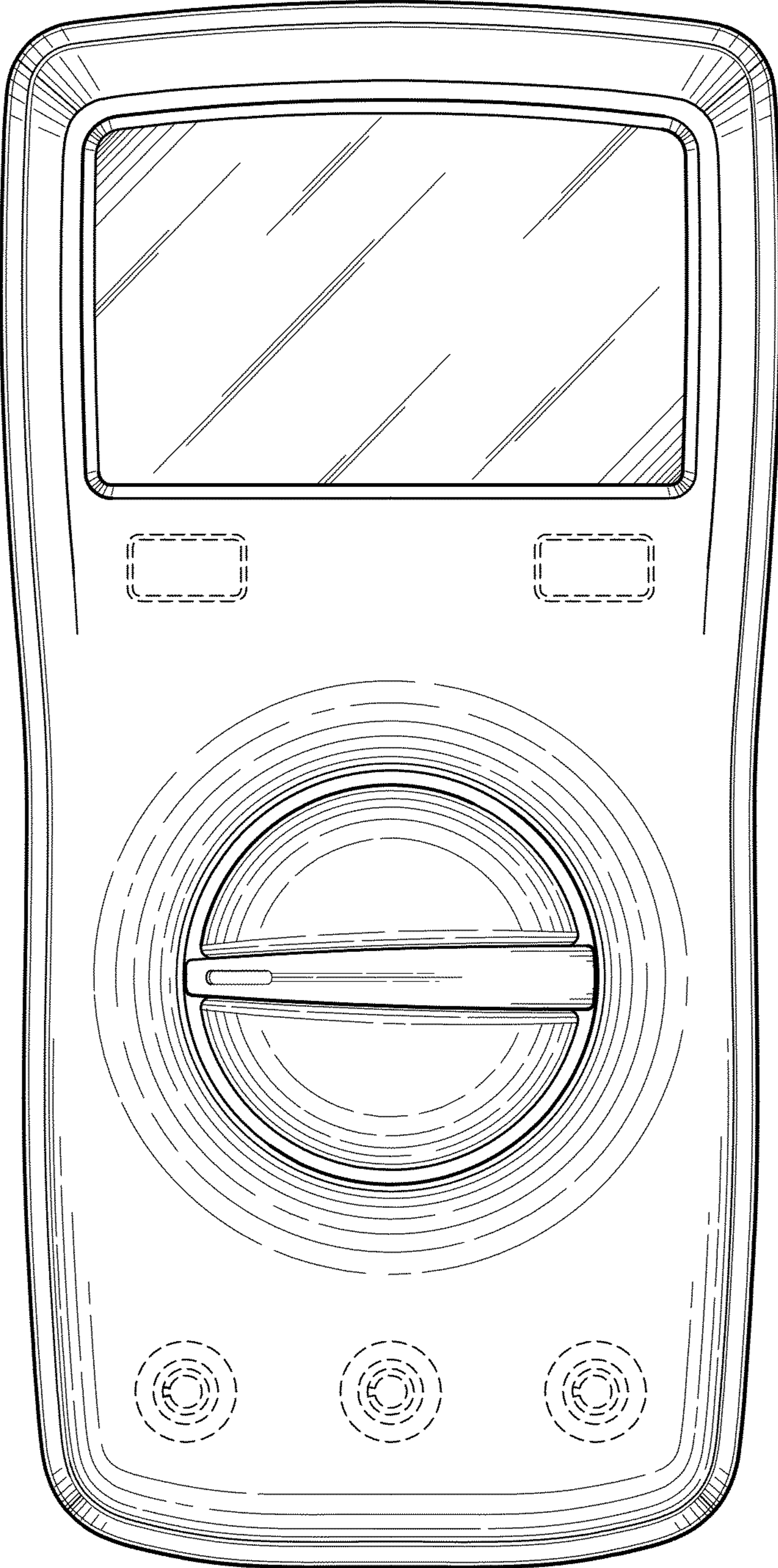
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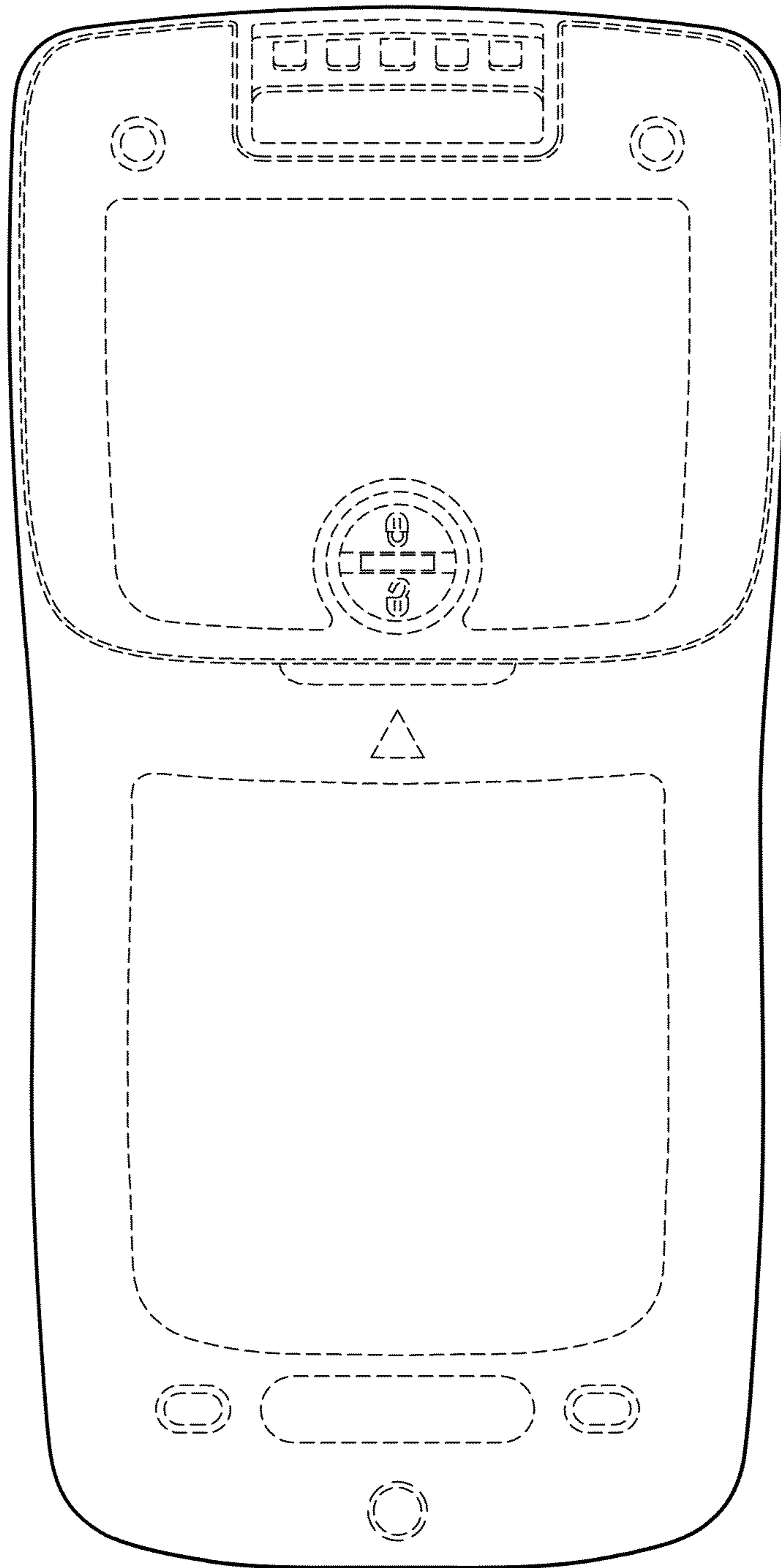
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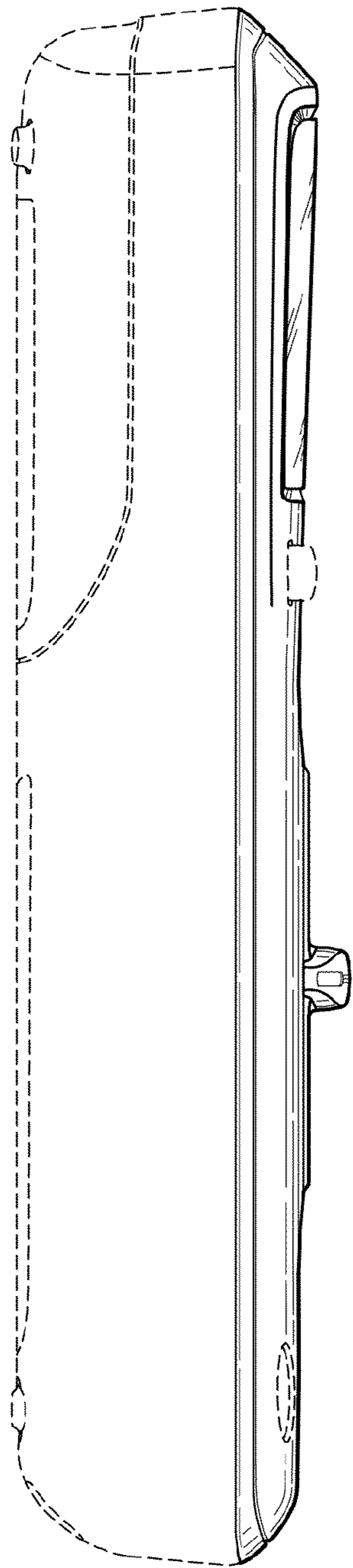
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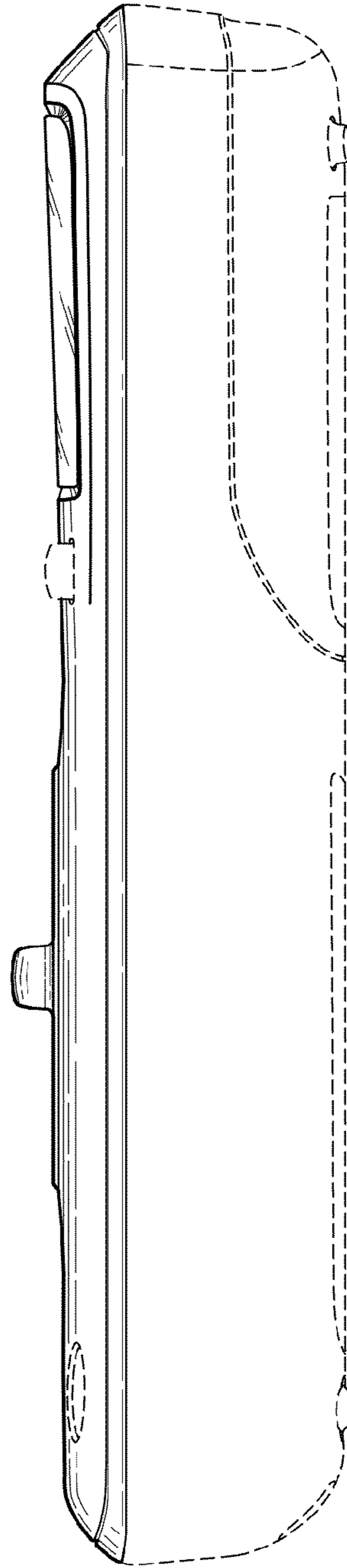
*Fig. 1.*



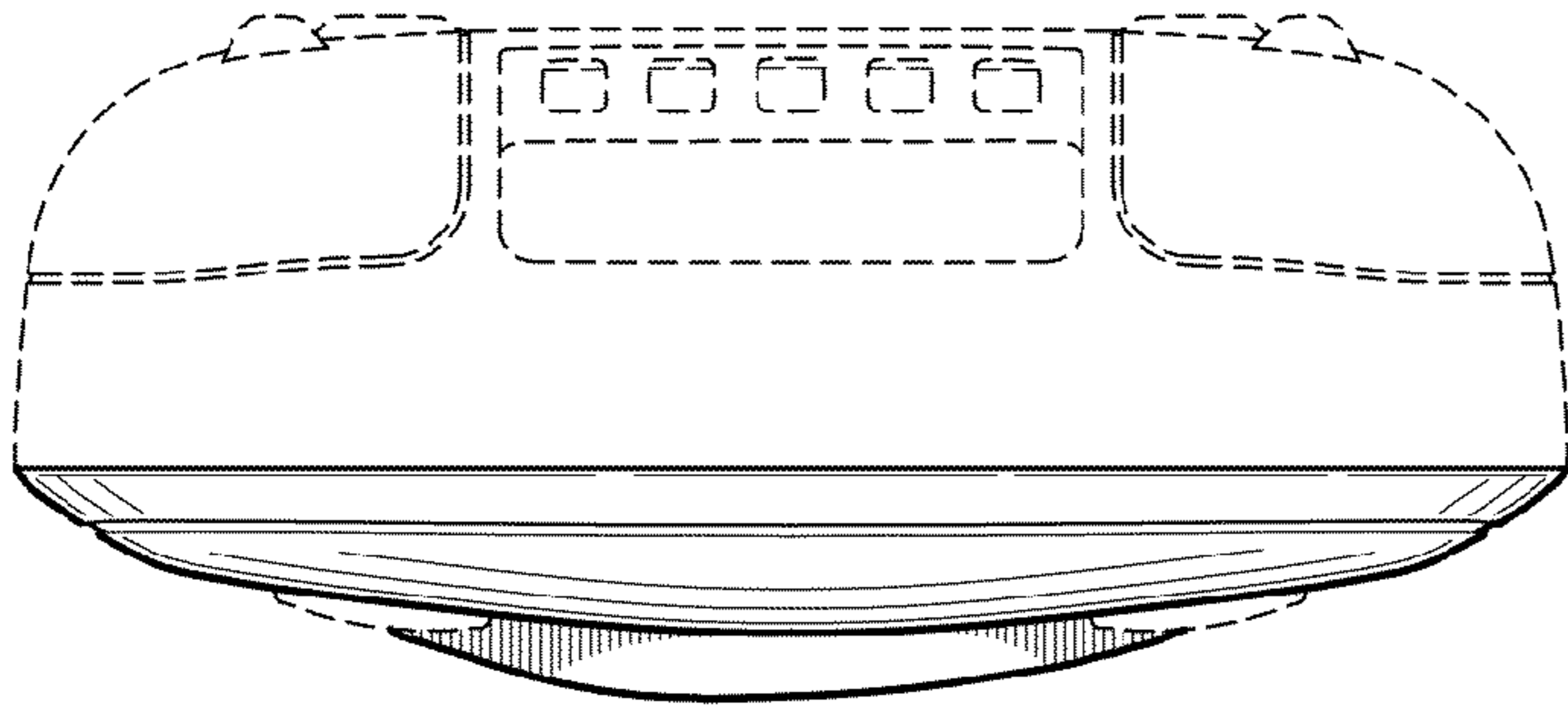
*Fig. 2.*



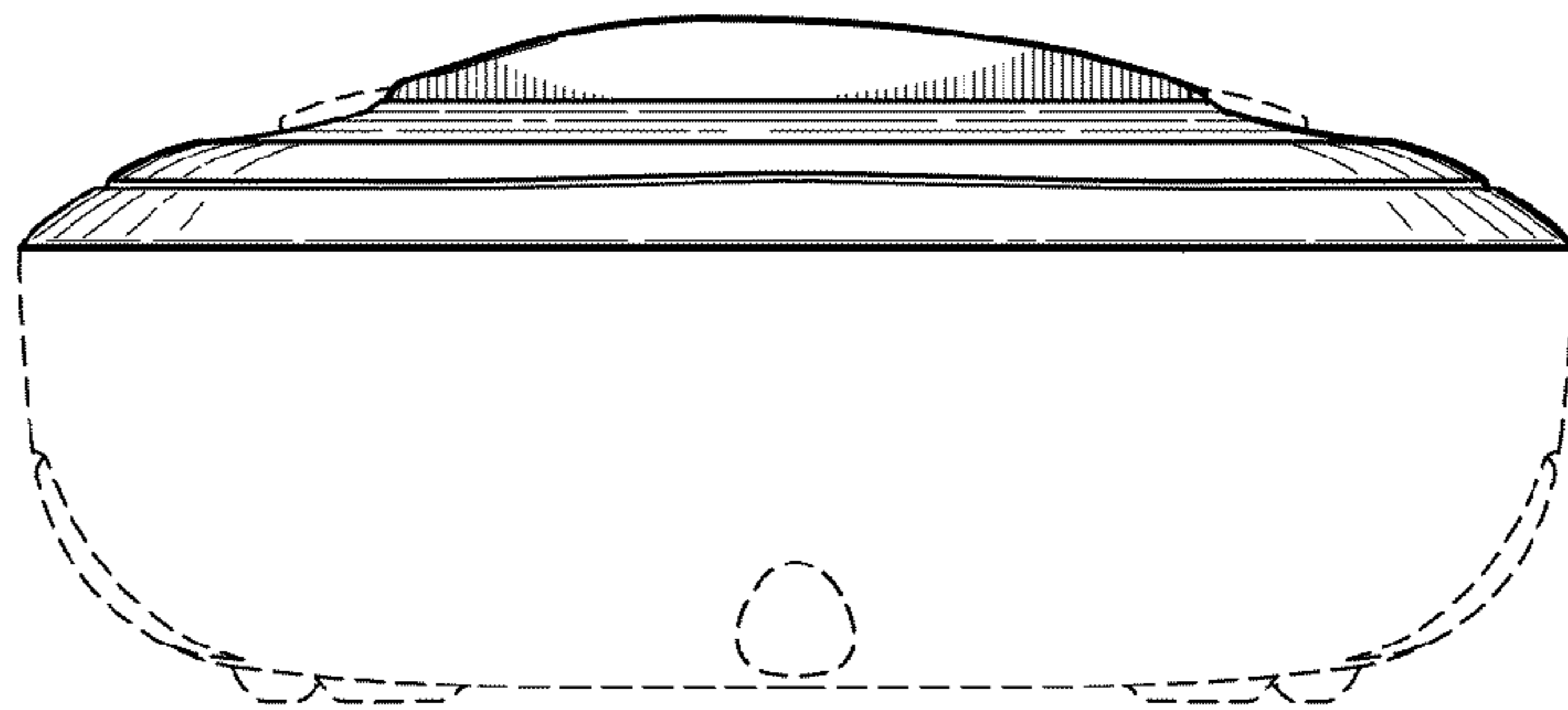
*Fig. 3.*



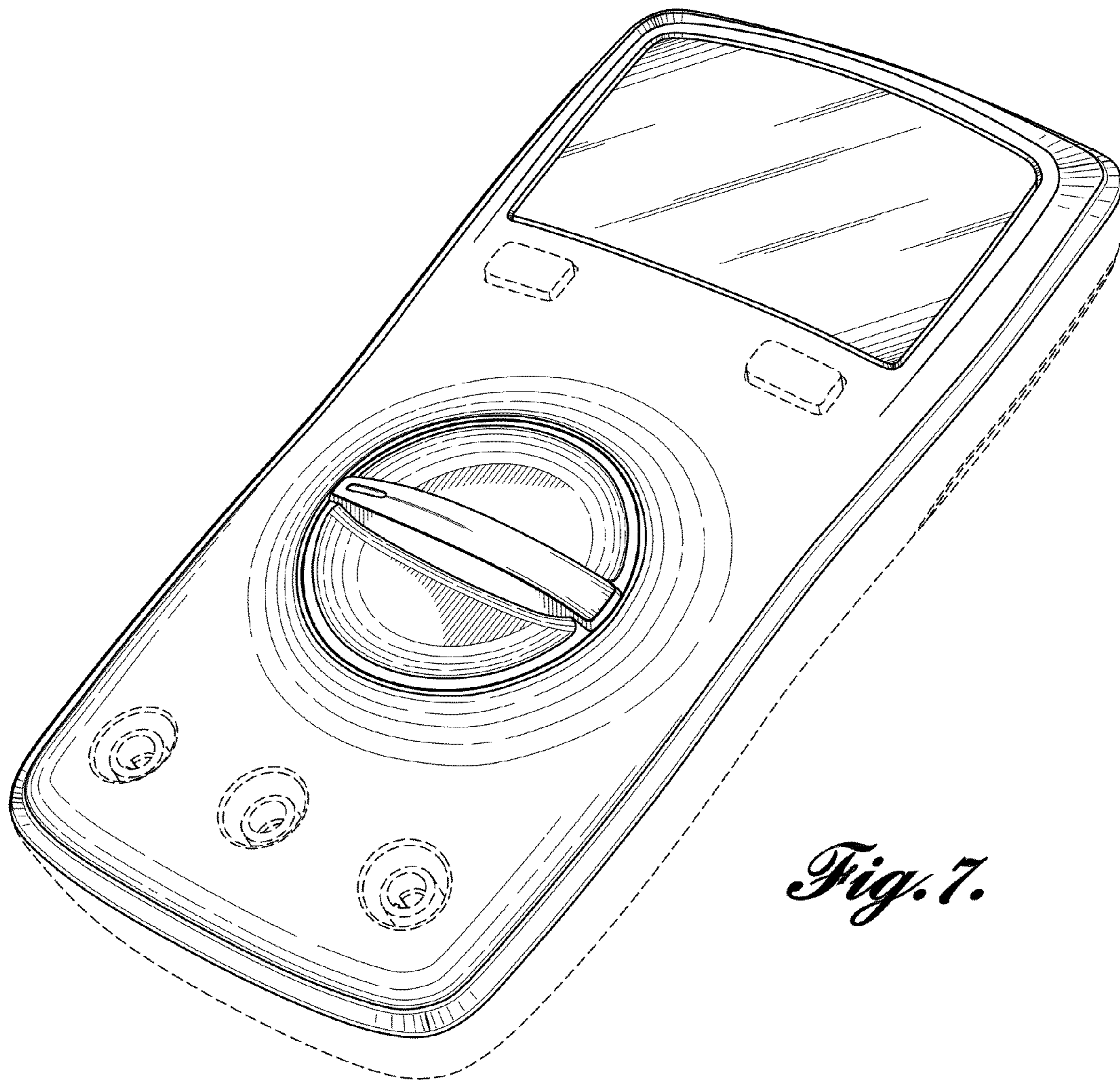
*Fig. 4.*



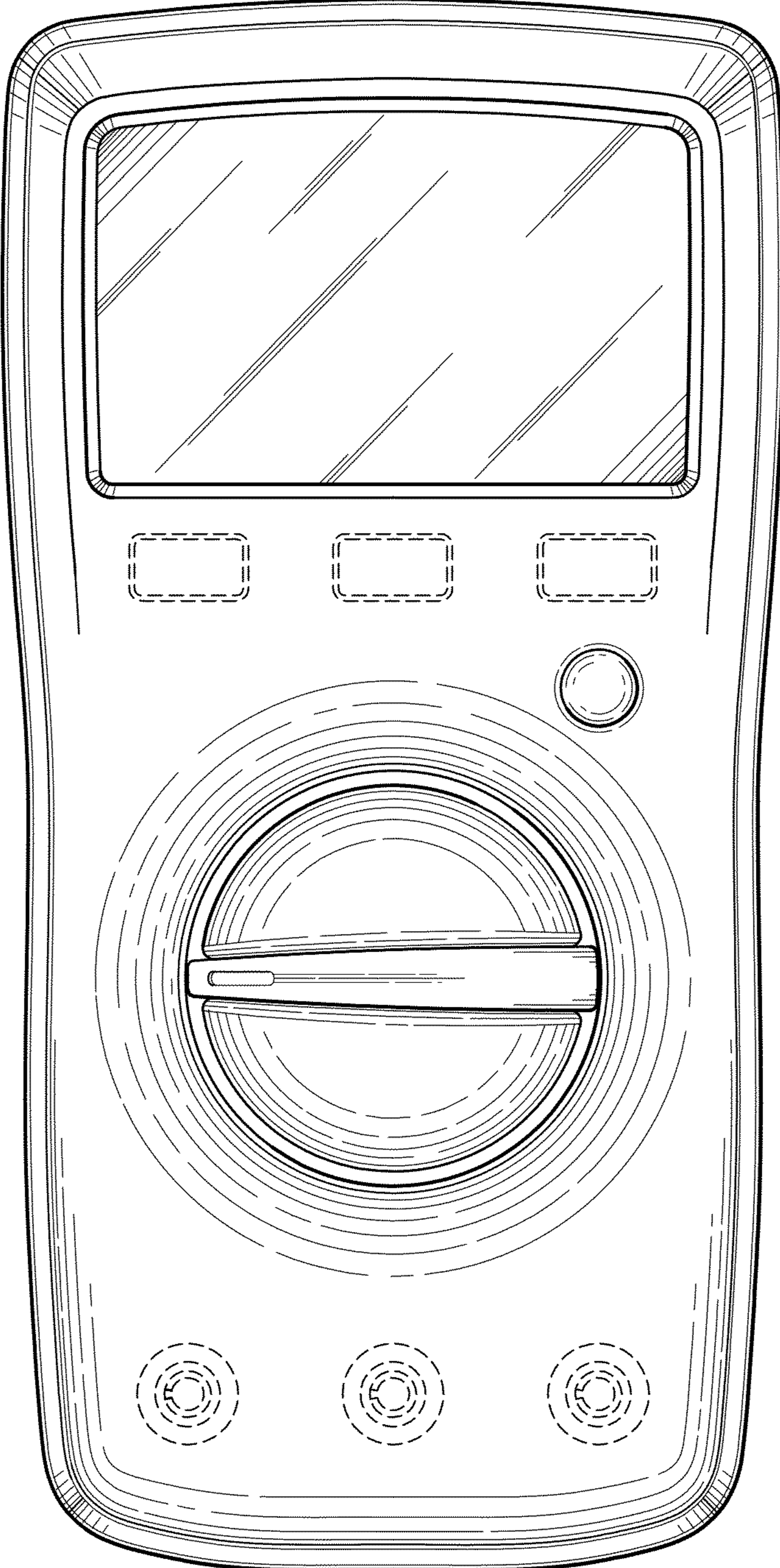
*Fig. 5.*



*Fig. 6.*

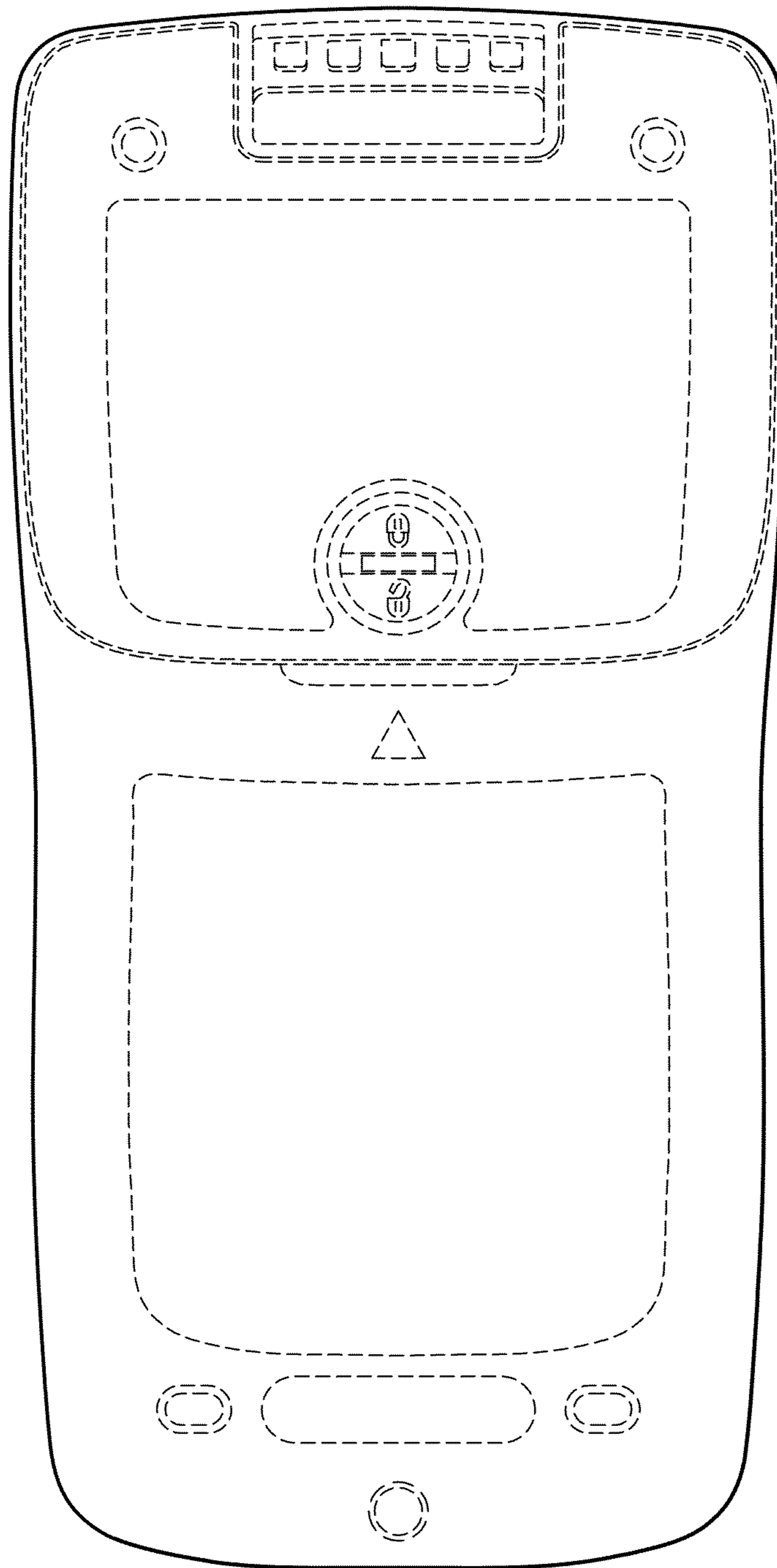


*Fig. 7.*

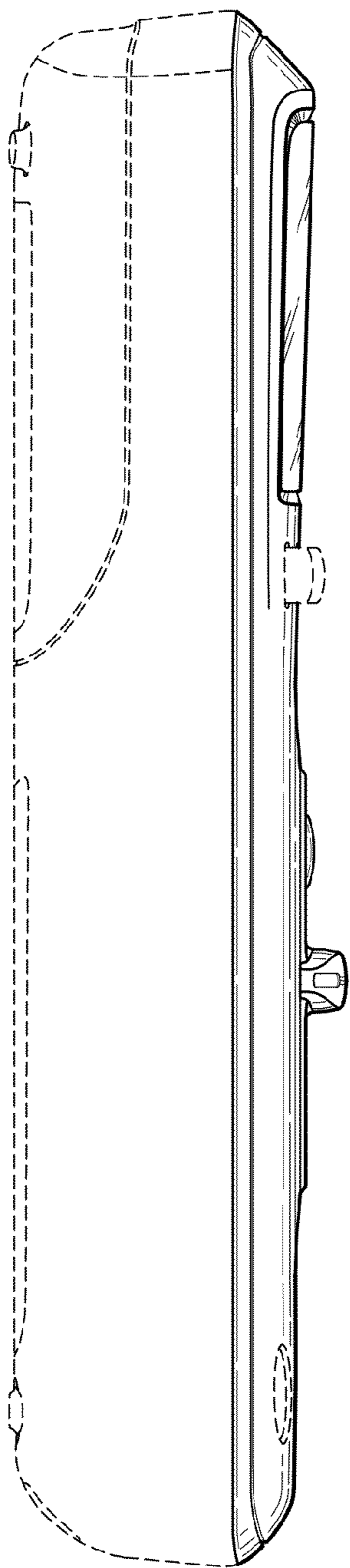


*Fig. 8.*

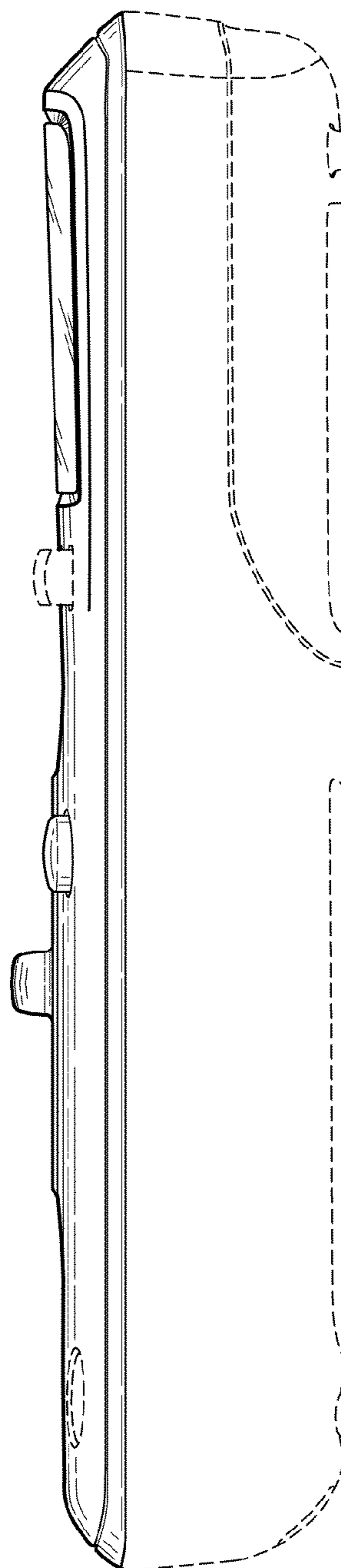




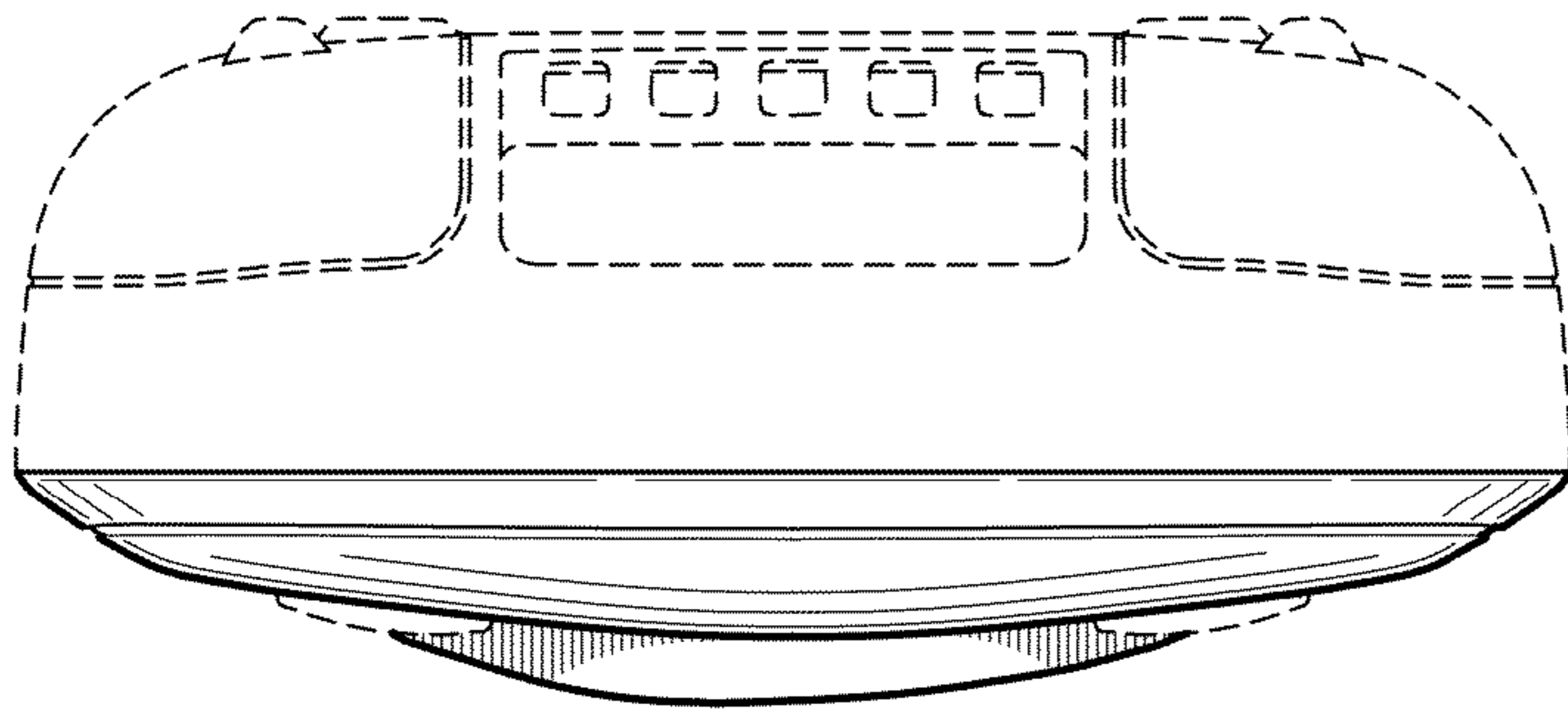
*Fig. 9.*



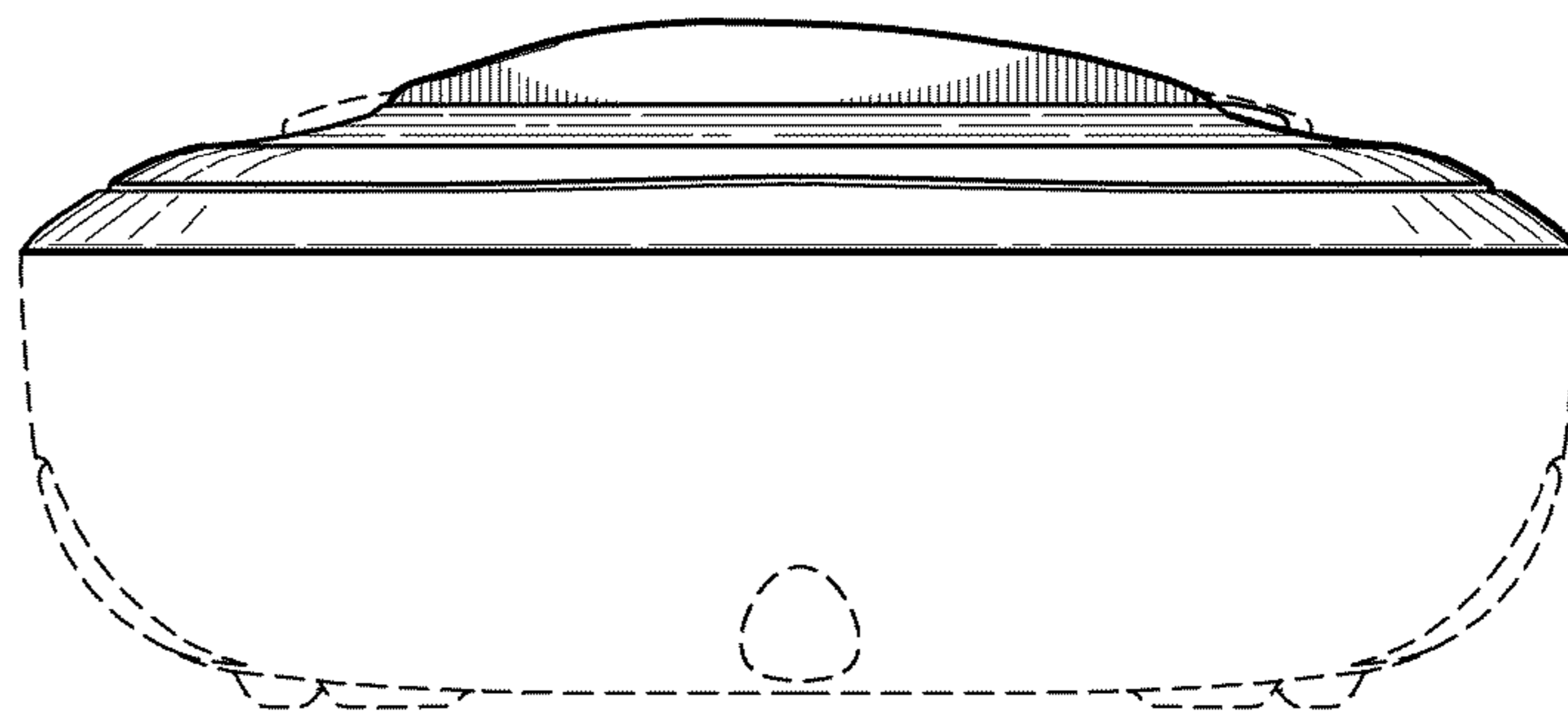
*Fig. 10.*



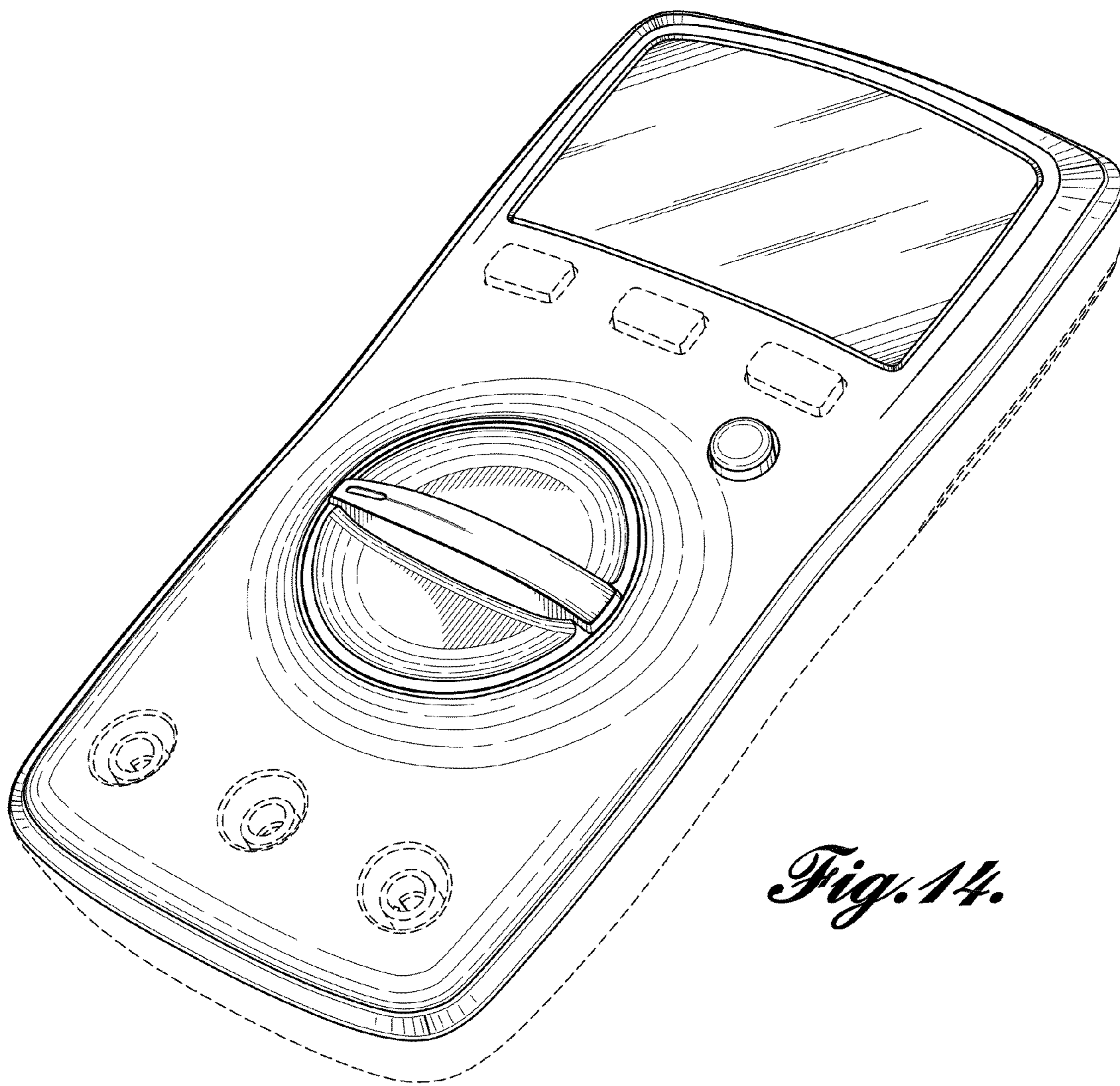
*Fig. 11.*



*Fig. 12.*



*Fig. 13.*



*Fig. 14.*